Handler Training

Trainer: Oxford Instruments Training Manager

Location: Oxford Instruments Plasma Technology UK Headquarters

Duration: 1 day

Places per session: 6

Suitable for: Equipment Engineers looking to develop the essential skills required to re-teach the robot, configure tool handling and complete a wafer size change.

Course details

Course will utilise the MMX and EMS training system robots – emphasis will be on tuition and practice in a controlled environment.

- Brooks/EMS terminology
- Elevator and wafer mapping configuration
- Basic set-up for the various facets/station
- Safety hub indicators
- Wafer size change – Aligner and loadport/elevator
- Handling recovery
- Wafer transfer
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